

Errata CCE4503 CE-IO-001

Abstract

This document contains the known errata for CCE4503 and the recommended workarounds.



1 Information

Datasheet	CCE4503
Package(s)	DFN10

2 Errata Summary

Table 1: Errata Summary

Issue #	Issue Title
1	First silicon
2	Short current threshold
3	Temperature shutdown

3 Errata Details

Table 2: First silicon

Issue #	Effect
1.	No comprehensive final test available to fully test all functionalitys.
	Conditions
	Errata only applies to first silicon before comprehensive test is available.
	Technical Description
	Before a comprehensive test is available, undiscovered errors or other unexpected or unintended behaviors might occur.
	These could be, for example:
	- Values out of specified range
	- Erroneous switching behavior
	-
	Workaround
	None



Table 3: Short current threshold

Issue #	Effect
2.	Short current threshold is out of specified range
	Conditions
	Short current to LM
	Technical Description
	The measured short current threshold is about 25% lower then specified.
	I _{limP} (to L-) at R _{ILIM} =0 Ohm has a mean value of 280 mA (should be 350 mA)
	I_{limP} (to L-) at R_{ILIM} =100 kOhm has a mean value of 35 mA (should be 50 mA)
	Workaround
	None

Table 4: Temperature shutdown

Issue #	Effect
3.	Shutdown occurs at restart temperature
	Conditions
	"RESTART" threshold is reached
	Technical Description
	The intended hysteresis does not work. The "SHUTDOWN" threshold (165 °C +/- 15 °C) is reached when temperature reaches the "RESTART" threshold (155 °C +/- 15 °C).
	Workaround
	None



Document Revision History

Revision	Date	Description
1	29-APR-2020	Initial version.



Status Definitions

Status	Definition	
DRAFT	The content of this document is under review and subject to formal approval, which may result in modifications or additions.	
APPROVED or unmarked	The content of this document has been approved for publication.	

Disclaimer

Unless otherwise agreed in writing, the Dialog Semiconductor products (and any associated software) referred to in this document are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of a Dialog Semiconductor product (or associated software) can reasonably be expected to result in personal injury, death or severe property or environmental damage. Dialog Semiconductor and its suppliers accept no liability for inclusion and/or use of Dialog Semiconductor products (and any associated software) in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Information in this document is believed to be accurate and reliable. However, Dialog Semiconductor does not give any representations or warranties, express or implied, as to the accuracy or completeness of such information. Dialog Semiconductor furthermore takes no responsibility whatsoever for the content in this document if provided by any information source outside of Dialog Semiconductor.

Dialog Semiconductor reserves the right to change without notice the information published in this document, including, without limitation, the specification and the design of the related semiconductor products, software and applications. Notwithstanding the foregoing, for any automotive grade version of the device, Dialog Semiconductor reserves the right to change the information published in this document, including, without limitation, the specification and the design of the related semiconductor products, software and applications, in accordance with its standard automotive change notification process.

Applications, software, and semiconductor products described in this document are for illustrative purposes only. Dialog Semiconductor makes no representation or warranty that such applications, software and semiconductor products will be suitable for the specified use without further testing or modification. Unless otherwise agreed in writing, such testing or modification is the sole responsibility of the customer and Dialog Semiconductor excludes all liability in this respect.

Nothing in this document may be construed as a license for customer to use the Dialog Semiconductor products, software and applications referred to in this document. Such license must be separately sought by customer with Dialog Semiconductor.

All use of Dialog Semiconductor products, software and applications referred to in this document is subject to Dialog Semiconductor's Standard Terms and Conditions of Sale, available on the company website (www.dialog-semiconductor.com) unless otherwise stated.

Dialog, Dialog Semiconductor and the Dialog logo are trademarks of Dialog Semiconductor Plc or its subsidiaries. All other product or service names and marks are the property of their respective owners.

© 2020 Dialog Semiconductor. All rights reserved.

Contacting Dialog Semiconductor

United Kingdom (Headquarters)

Dialog Semiconductor (UK) LTD Phone: +44 1793 757700

Germany

Dialog Semiconductor Creative Chips GmbH Phone: +49 6721 98722-0

The Netherlands

Dialog Semiconductor B.V.

Phone: +31 73 640 8822

Email:

enquiry@diasemi.com

North America

Dialog Semiconductor Inc. Phone: +1 408 845 8500

Japan

Dialog Semiconductor K. K. Phone: +81 3 5769 5100

Taiwan

Dialog Semiconductor Taiwan Phone: +886 281 786 222

Web site:

www.dialog-semiconductor.com

Hong Kong China (Shenzhen)

Dialog Semiconductor Korea

Phone: +82 2 3469 8200

Dialog Semiconductor Hong Kong Dialog Semiconductor China
Phone: +852 2607 4271 Phone: +86 755 2981 3669

China (Shanghai)

Dialog Semiconductor China Phone: +86 21 5424 9058

Errata Revision 1 29-APR-2020